

IGBT (NPT) Module

$$V_{CES} = 1200V$$

$$I_{C25} = 90A$$

$$V_{CE(sat)} = 2.2V$$


Boost Chopper + free wheeling Diode

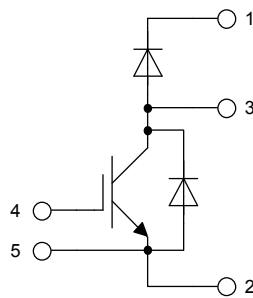
Part number

MID75-12A3



Backside: isolated

 E72873



Features / Advantages:

- NPT IGBT technology
- low saturation voltage
- low switching losses
- switching frequency up to 30 kHz
- square RBSOA, no latch up
- high short circuit capability
- positive temperature coefficient for easy parallelling
- MOS input, voltage controlled
- ultra fast free wheeling diodes

Applications:

- AC motor drives
- Solar inverter
- Medical equipment
- Uninterruptible power supply
- Air-conditioning systems
- Welding equipment
- Switched-mode and resonant-mode power supplies
- Inductive heating, cookers
- Pumps, Fans

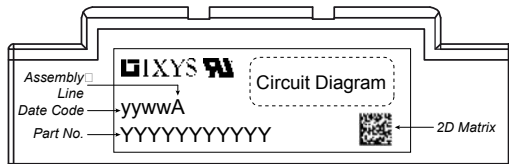
Package: Y4

- Isolation Voltage: 3600 V~
- Industry standard outline
- RoHS compliant
- Soldering pins for PCB mounting
- Base plate: DCB ceramic
- Reduced weight
- Advanced power cycling

Free Wheeling Diode FWD				Ratings		
Symbol	Definition	Conditions	min.	typ.	max.	Unit
V_{RSM}	max. non-repetitive reverse blocking voltage	$T_{VJ} = 25^{\circ}C$			1200	V
V_{RRM}	max. repetitive reverse blocking voltage	$T_{VJ} = 25^{\circ}C$			1200	V
I_R	reverse current, drain current	$V_R = 1200 V$	$T_{VJ} = 25^{\circ}C$		650	μA
		$V_R = 1200 V$	$T_{VJ} = 125^{\circ}C$		2	mA
V_F	forward voltage drop	$I_F = 50 A$	$T_{VJ} = 25^{\circ}C$		2.50	V
		$I_F = 100 A$			3.00	V
		$I_F = 50 A$	$T_{VJ} = 125^{\circ}C$		1.90	V
		$I_F = 100 A$			2.30	V
I_{FAV}	average forward current	$T_C = 80^{\circ}C$	$T_{VJ} = 150^{\circ}C$		60	A
		DC current $d = 1$				
V_{FO}	threshold voltage	} for power loss calculation only	$T_{VJ} = 150^{\circ}C$		1.30	V
r_F	slope resistance				12	m Ω
R_{thJC}	thermal resistance junction to case				0.66	K/W
R_{thCH}	thermal resistance case to heatsink			0.66		K/W
P_{tot}	total power dissipation		$T_C = 25^{\circ}C$		190	W
I_{FSM}	max. forward surge current	$t = 10 ms; (50 Hz), sine; V_R = 0 V$	$T_{VJ} = 45^{\circ}C$		400	A
C_J	junction capacitance	$V_R = 600 V f = 1 MHz$	$T_{VJ} = 25^{\circ}C$		30	pF

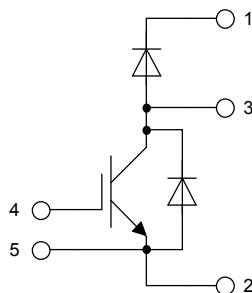
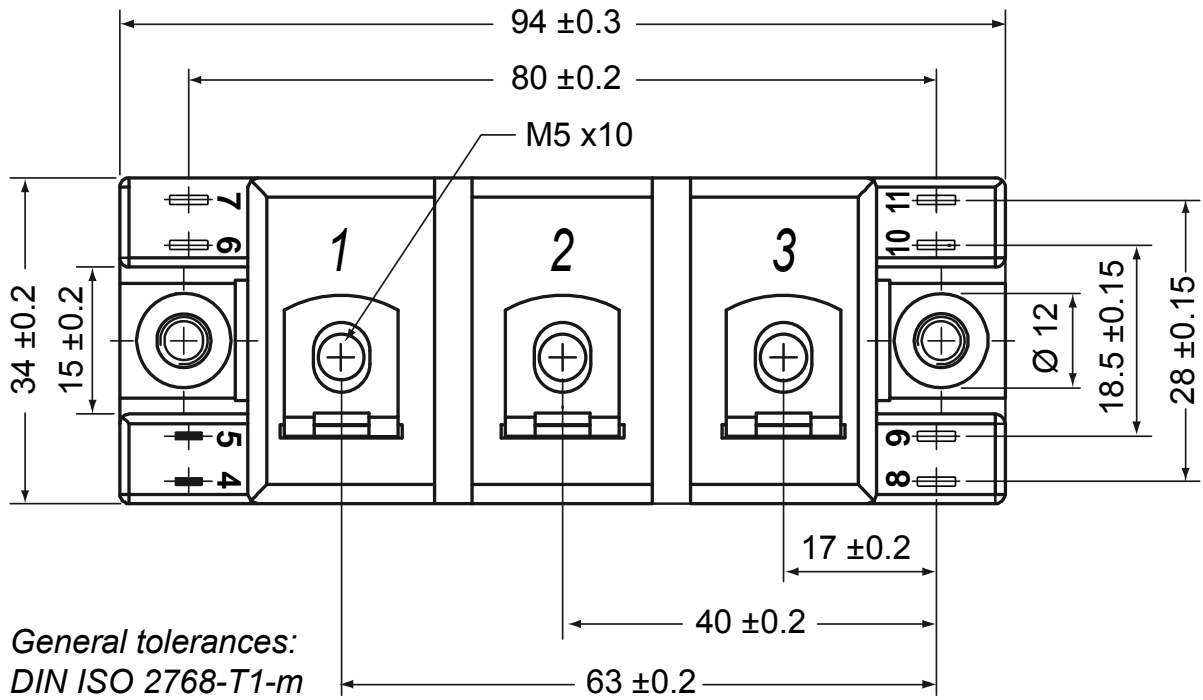
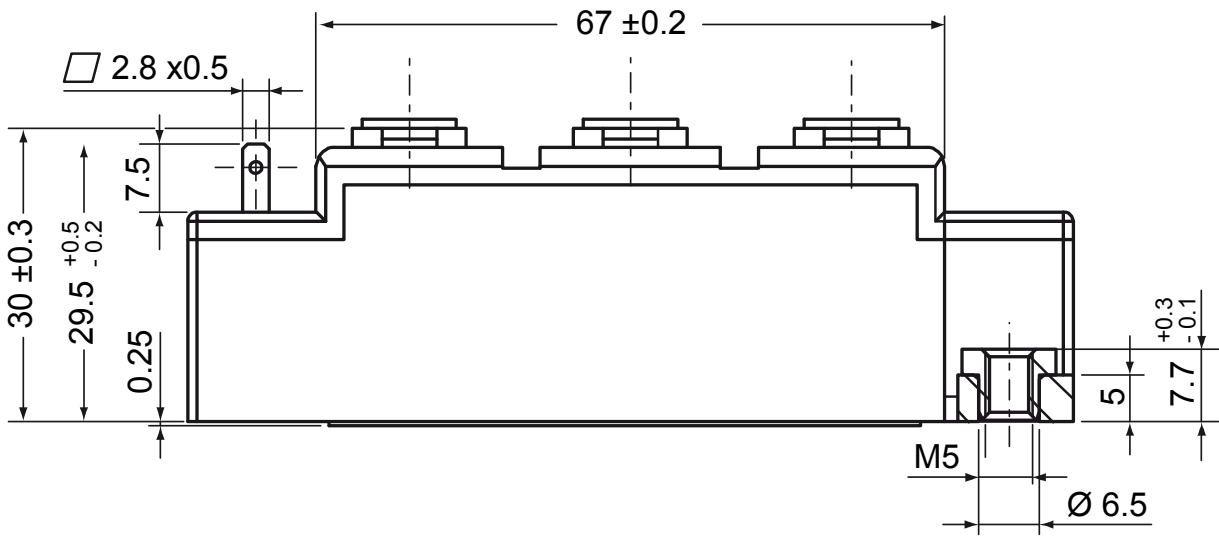
Boost IGBT				Ratings			
Symbol	Definition	Conditions	min.	typ.	max.	Unit	
V_{CES}	collector emitter voltage	$T_{VJ} = 25^{\circ}C$			1200	V	
V_{GES}	max. DC gate voltage				± 20	V	
V_{GEM}	max. transient gate emitter voltage				± 30	V	
I_{C25}	collector current	$T_C = 25^{\circ}C$			90	A	
I_{C80}		$T_C = 80^{\circ}C$			60	A	
P_{tot}	total power dissipation	$T_C = 25^{\circ}C$			370	W	
$V_{CE(sat)}$	collector emitter saturation voltage	$I_C = 50A; V_{GE} = 15V$			2.2	V	
					2.7	V	
$V_{GE(th)}$	gate emitter threshold voltage	$I_C = 2mA; V_{GE} = V_{CE}$	4.5	5.5	6.5	V	
I_{CES}	collector emitter leakage current	$V_{CE} = V_{CES}; V_{GE} = 0V$			4	mA	
					6	mA	
I_{GES}	gate emitter leakage current	$V_{GE} = \pm 20V$			200	nA	
$Q_{G(on)}$	total gate charge	$V_{CE} = 600V; V_{GE} = 15V; I_C = 50A$		240		nC	
$t_{d(on)}$	turn-on delay time	inductive load $V_{CE} = 600V; I_C = 50A$ $V_{GE} = \pm 15V; R_G = 22\Omega$		100		ns	
t_r	current rise time			70		ns	
$t_{d(off)}$	turn-off delay time			500		ns	
t_f	current fall time			70		ns	
E_{on}	turn-on energy per pulse			7.6		mJ	
E_{off}	turn-off energy per pulse			5.6		mJ	
RBSOA	reverse bias safe operating area	$V_{GE} = \pm 15V; R_G = 22\Omega$					
I_{CM}		$V_{CEmax} = 1200V$			100	A	
SCSOA	short circuit safe operating area	$V_{CEmax} = 1200V$					
t_{sc}	short circuit duration	$V_{CE} = 1200V; V_{GE} = \pm 15V$			10	μs	
I_{sc}	short circuit current	$R_G = 22\Omega; \text{non-repetitive}$		180		A	
R_{thJC}	thermal resistance junction to case				0.33	K/W	
R_{thCH}	thermal resistance case to heatsink				0.33	K/W	
Boost Diode BD							
V_{RRM}	max. repetitive reverse voltage	$T_{VJ} = 25^{\circ}C$			1200	V	
I_{F25}	forward current	$T_C = 25^{\circ}C$			100	A	
I_{F80}		$T_C = 80^{\circ}C$			60	A	
V_F	forward voltage	$I_F = 50A$			2.50	V	
				1.80		V	
I_R	reverse current	$V_R = V_{RRM}$			0.65	mA	
				1		mA	
Q_{rr}	reverse recovery charge	$V_R = 600V$ $-di_F/dt = 400A/\mu s$ $I_F = 50A; V_{GE} = 0V$		3.5		μC	
I_{RM}	max. reverse recovery current			40		A	
t_{rr}	reverse recovery time			200		ns	
E_{rec}	reverse recovery energy			1		mJ	
R_{thJC}	thermal resistance junction to case				0.66	K/W	
R_{thCH}	thermal resistance case to heatsink				0.66	K/W	

Package Y4				Ratings		
Symbol	Definition	Conditions	min.	typ.	max.	Unit
I_{RMS}	RMS current	per terminal			300	A
T_{VJ}	virtual junction temperature		-40		150	°C
T_{op}	operation temperature		-40		125	°C
T_{stg}	storage temperature		-40		125	°C
Weight					108	g
M_D	mounting torque		2.25		2.75	Nm
M_T	terminal torque		4.5		5.5	Nm
$d_{Spp/App}$	creepage distance on surface striking distance through air	terminal to terminal	14.0	10.0		mm
$d_{Spb/Apb}$		terminal to backside	16.0	16.0		mm
V_{ISOL}	isolation voltage	t = 1 second			3600	V
		t = 1 minute	50/60 Hz, RMS; $I_{ISOL} \leq 1$ mA		3000	V



Ordering	Part Number	Marking on Product	Delivery Mode	Quantity	Code No.
Standard	MID75-12A3	MID75-12A3	Box	6	474193

Outlines Y4



Boost IGBT

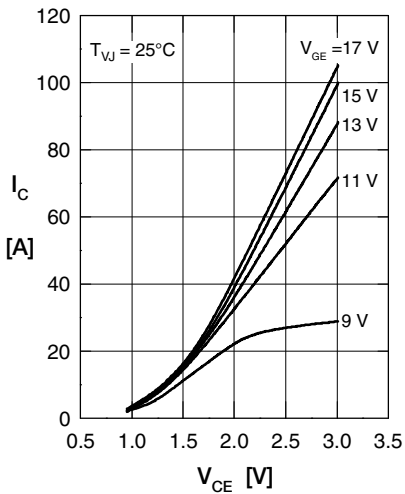


Fig. 1 Typ. output characteristics

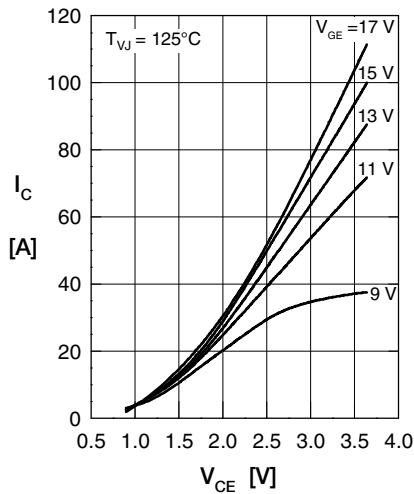


Fig. 2 Typ. output characteristics

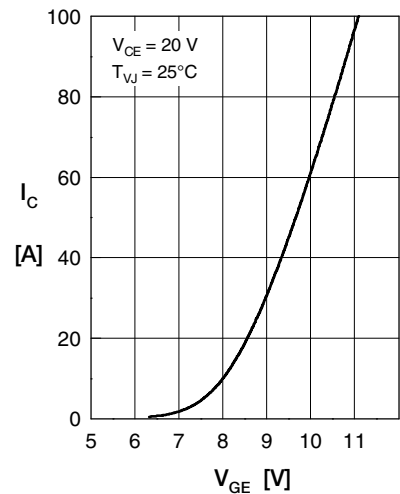


Fig. 3 Typ. transfer characteristics

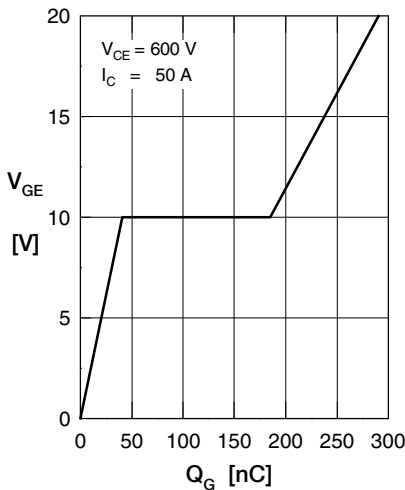


Fig. 4 Typ. turn-on gate charge

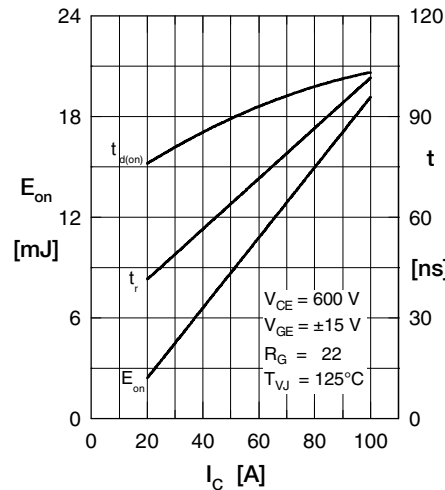


Fig. 5 Typ. turn on energy & switching times versus collector current

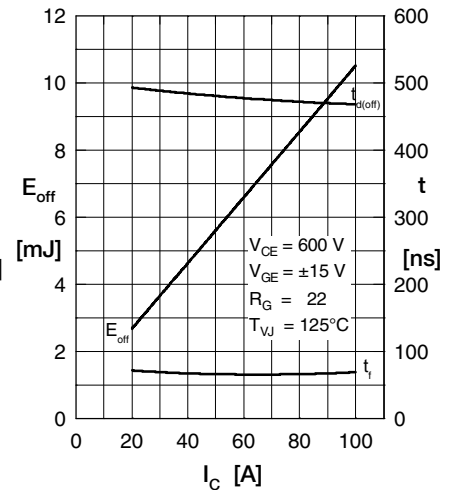


Fig. 6 Typ. turn off energy & switching times versus collector current

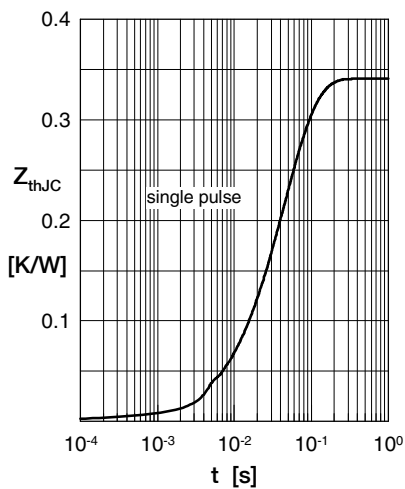


Fig. 12 Typical transient thermal impedance

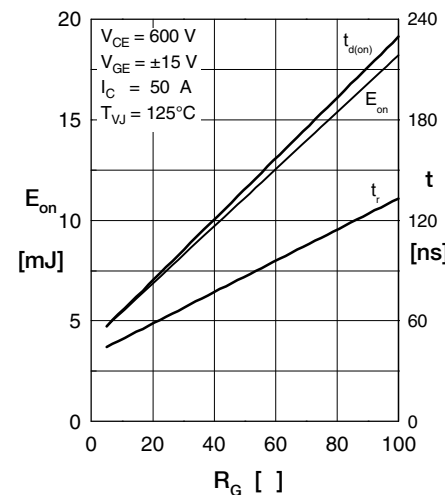


Fig. 9 Typ. turn on energy & switching times versus gate resistor

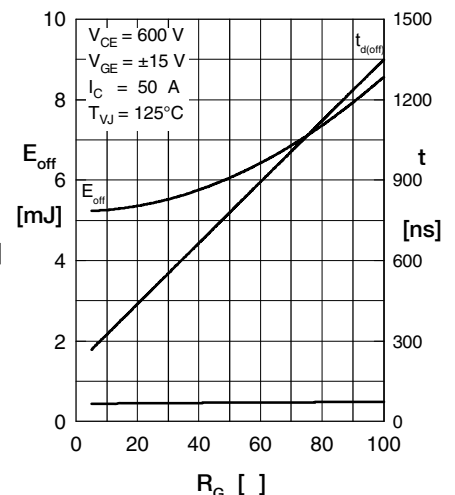


Fig. 9 Typ. turn off energy & switching times versus gate resistor

Boost Diode BD

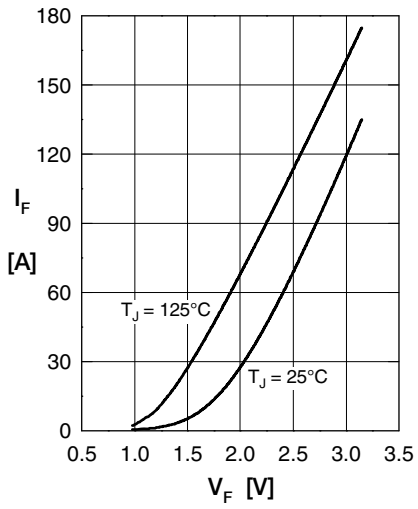


Fig. 1 Typ. Forward current vs. V_F

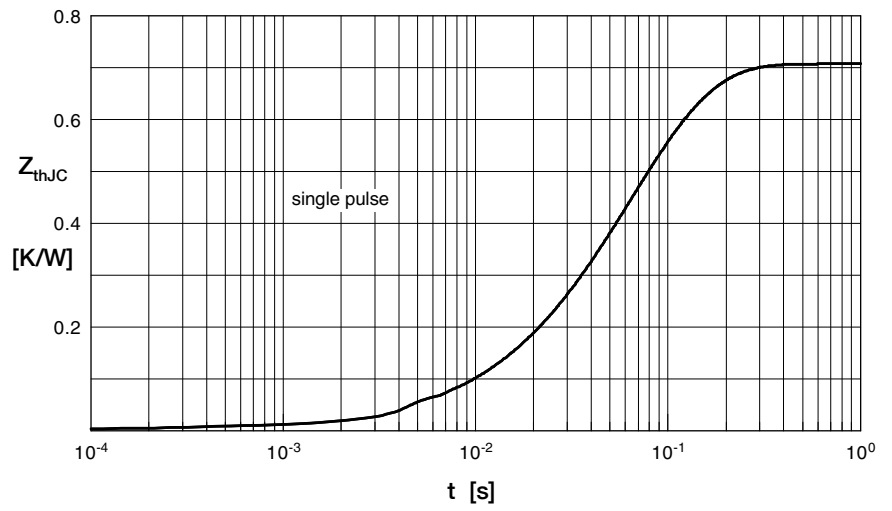


Fig. 2 Typ. transient thermal impedance junction to case



Компания «ЭлектроПласт» предлагает заключение долгосрочных отношений при поставках импортных электронных компонентов на взаимовыгодных условиях!

Наши преимущества:

- Оперативные поставки широкого спектра электронных компонентов отечественного и импортного производства напрямую от производителей и с крупнейших мировых складов;
- Поставка более 17-ти миллионов наименований электронных компонентов;
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- Лицензия ФСБ на осуществление работ с использованием сведений, составляющих государственную тайну;
- Поставка специализированных компонентов (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Aeroflex, Peregrine, Syfer, Eurofarad, Texas Instrument, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

Помимо этого, одним из направлений компании «ЭлектроПласт» является направление «Источники питания». Мы предлагаем Вам помощь Конструкторского отдела:

- Подбор оптимального решения, техническое обоснование при выборе компонента;
- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



Как с нами связаться

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